

Q.P. Code : 588801

(3 Hours)

[Total Marks : 80]

- N.B. :** (1) Question **ONE** is **compulsory**.
 (2) Solve **any THREE** out of remaining **questions**.
 (3) Draw **neat and clean diagrams**.
 (4) Assume **suitable data** if **required**.

1. Attempt **any FOUR** from the following :

- (a) For NMOS resistive load inverter with $R_L = 50K$ find V_{IL} and V_{OH} if $V_{DD} = 5V$, $V_{TO} = 1V$, $K_n = 100 \mu A/V^2$, neglect body bias effect and channel length modulation. **20**
- (b) With help of appropriate circuit diagram and waveforms, explain charge sharing problem of dynamic logic. How to overcome the same.
- (c) Explain the significance of Level - 1 MOSFET model parameters.
- (d) Implement 4: 1 MUX using Transmission gate technology.
- (e) Explain advantages and disadvantages of Pass Transistor logic in VLSI Design.
2. (a) Explain working of CMOS Inverter with help of Voltage Transfer Characteristics and derive expression for V_{IL} and V_{IH} . **10**
- (b) Implement 1 - bit full adder circuit using standard CMOS logic, dynamic logic and pseudo NMOS logic. **10**
3. (a) Draw six transistors SRAM cell and explain its read 0, read 1, write 0 and write 1 operation with the help of appropriate waveforms. **10**
- (b) What is Carry Look Ahead (CLA) adder. Write equations for carry bits of 5-bit CLA in terms of input bits only i.e carry generate and carry propagate and implement the same using domino logic. **10**
4. (a) For 2 input CMOS NAND gate find V_{OL} , V_{OH} , V_{IH} , and V_{IL} . Assume that both the inputs are switching simultaneously. Consider NMOS and PMOS with following parameters. $V_{DD} = 5V$, $V_{TO_n} = 1V$, $K_n = 100 \mu A/V^2$, $V_{TO_p} = -1V$, $K_p = 25 \mu A/V^2$. **10**
- (b) Give NMOS fabrication process flow with help of neat sketches of appropriate masks and cross section at each process steps. **10**

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2

5. (a) Implement 4x4 NAND based ROM array to store "1001", "0101", "1010" and "1100" in the memory. **5**
- (b) Explain the effect of Interconnect scaling on various performance parameters of VLSI circuits. **10**
- (c) Draw layout of 3 transistor (3-T) DRAM cell using lambda rules. **5**
6. Write short notes on **any FOUR** : **20**
- (a) Power Distribution schemes
 - (b) Array Multiplier
 - (c) Interconnect Delay Model
 - (d) NAND Flash Memory
 - (e) Column Decoders
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